RoHS

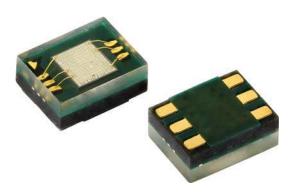
HALOGEN

FREE GREEN



Vishay Semiconductors

UVA Light Sensor with I²C Interface



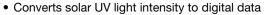
DESCRIPTION

VEML6070 is an advanced ultraviolet (UV) light sensor with I²C protocol interface and designed by the CMOS process. It is easily operated via a simple I²C command. The active acknowledge (ACK) feature with threshold windows setting allows the UV sensor to send out a UVI alert message. Under a strong solar UVI condition, the smart ACK signal can be easily implemented by the software programming.

VEML6070 incorporates a photodiode, amplifiers, and analog / digital circuits into a single chip. VEML6070's adoption of Filtron UV technology provides the best spectral sensitivity to cover UV spectrum sensing. It has an excellent temperature compensation and a robust refresh rate setting that does not use an external RC low pass filter. VEML6070 has linear sensitivity to solar UV light and is easily adjusted by an external resistor. Software shutdown mode is provided, which reduces power consumption to be less than 1 μ A. VEML6070's operating voltage ranges from 2.7 V to 5.5 V.

FEATURES

- Package type: surface mount
- Dimensions (L x W x H in mm): 2.35 x 1.8 x 1.0
- Integrated modules: ultraviolet sensor (UV), and signal conditioning IC



- Excellent UV sensitivity and linearity via FiltronTM technology
- Excellent performance of UV radiation measurement under long time solar UV exposure
- Excellent temperature compensation
- High dynamic detection resolution
- Standard I²C protocol interface
- Support acknowledge feature (ACK)
- Immunity on fluorescent light flicker software shutdown mode control
- Package: OPLGA
- Temperature compensation: -40 °C to +85 °C
- Floor life: 168 h, MSL 3, according to J-STD-020
- Output type: I²C bus
- Operation voltage: 2.7 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Solar UV indicator
- · Cosmetic / outdoor sport handheld product
- Consumer products

PRODUCT SU	JMMARY				
PART NUMBER	OPERATING VOLTAGE RANGE (V)	I ² C BUS VOLTAGE RANGE (V)	PEAK SENSITIVITY (nm)	RANGE OF SPECTRAL BANDWIDTH $\lambda_{0.5}$ (nm)	OUTPUT CODE
VEML6070	2.7 to 5.5	1.7 to 5.5	355	± 20	16 bit, I ² C

Note

(1) Adjustable through I2C interface

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
VEML6070	Tape and reel	MOQ: 2500 pcs	2.35 mm x 1.8 mm x 1.0 mm

Note

(1) MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)											
PARAMETER	TEST CONDITION	TEST CONDITION SYMBOL MIN. MAX. UNIT									
Supply voltage		V_{DD}	0	6.0	V						
Operation temperature range		T _{amb}	-40	+85	°C						



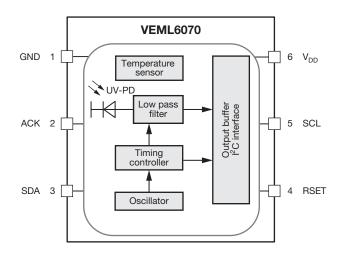
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RECOMMENDED OPERATING CONDITIONS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	TEST CONDITION SYMBOL MIN. MAX. UNIT								
Supply voltage		V_{DD}	2.7	5.5	V				
Operation temperature range		T _{amb}	-40	+85	°C				
I ² C bus operating frequency		f _(I2CCLK)	10	400	kHz				

PIN DESCRIPTIONS				
PIN ASSIGNMENT	SYMBOL	TYPE	FUNCTION	
1	GND	I	Power supply ground, all voltage are reference to GND	
2	ACK	O (open drain) Acknowledge pin		
3	SDA	I / O (open drain)	I ² C digital serial data output to the host	
4	RSET		Light reading adjustment, connect a resistor to GND	
5	SCL	I I ² C digital serial clock input from the host		
6	V _{DD}	I	Supply voltage	

BLOCK DIAGRAM



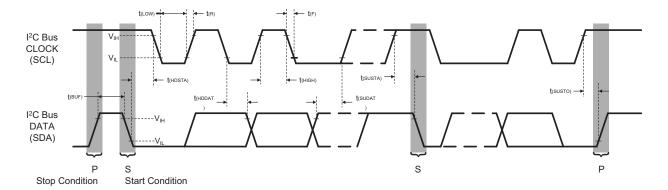
BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Supply operation voltage		V_{DD}	2.7	-	5.5	V		
Supply current	$R_{SET} = 240 \text{ k}\Omega^{(1)(2)}$	I _{DD}	-	100	250	μΑ		
I ² C signal input Logic high	(1)(2)	V _{IH}	1.5	-	V_{DD}	V		
Logic low	(1/(-)	V _{IL}	-	-	0.8	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Peak sensitivity wavelength		λ_{p}	-	355	-	nm		
Range of spectral sensitivity		λ _{0.1}	320	-	410	nm		
UVA sensitivity	$R_{SET} = 240 \text{ k}\Omega, \text{ IT} = 1\text{T}^{(3)}$		-	5	-	μW/cm²/step		
Maximum UVA detection power	$R_{SET} = 240 \text{ k}\Omega, \text{ IT} = 1\text{T}^{(3)}$		-	-	328	mW/cm ²		
Dark offset	$R_{SET} = 240 \text{ k}\Omega, \text{ IT} = 1\text{T}^{(3)}$		0	1	5	steps		
Output offset	$R_{SET} = 240 \text{ k}\Omega, \text{ IT} = 1\text{T}^{(1)(4)}$		-	2	-	steps		
Shutdown current	Light condition = dark (1)	I _{DD}	-	1	15	μΑ		

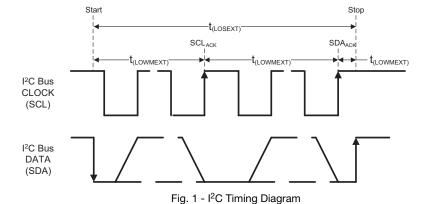
Notes

- $^{(1)}$ Test condition: $V_{DD} = 3.3 \text{ V}$, temperature: 25°C
- (2) Light source: solar light source
- (3) Test using 365 nm UVA LED
- (4) Ambient light intensity = 500 lx



I ² C TIMING CHARACTERISTICS (T	I ² C TIMING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	SYMBOL	STANDAI	RD MODE	FAST	MODE	UNIT		
PANAMETEN	STIMBOL	MIN.	MAX.	MIN.	MAX.	ONIT		
Clock frequency	f _(SMBCLK)	10	100	10	400	kHz		
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	-	μs		
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μs		
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	-	μs		
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	-	μs		
Data hold time	t _(HDDAT)		3450	ı	900	ns		
Data setup time	t _(SUDAT)	250	-	100	-	ns		
I ² C clock (SCK) low period	t _(LOW)	4.7	-	1.3	-	μs		
I ² C clock (SCK) high period	t _(HIGH)	4.0	-	0.6	-	μs		
Detect clock / data low timeout	t _(TIMEOUT)	25	35	-	-	ms		
Clock / data fall time	t _(F)	-	300	-	300	ns		
Clock / data rise time	t _(R)	-	1000	-	300	ns		







PARAMETER TIMING INFORMATION

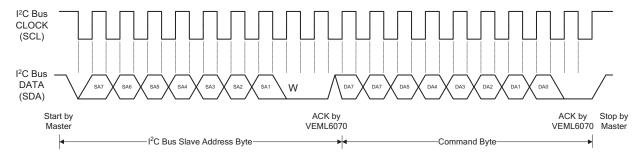


Fig. 2 - Timing for Send Byte Command Format

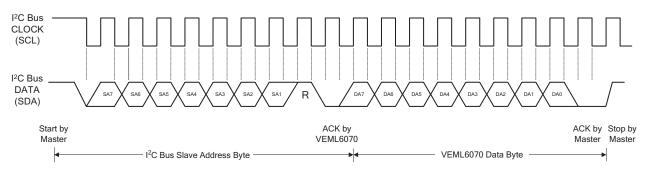
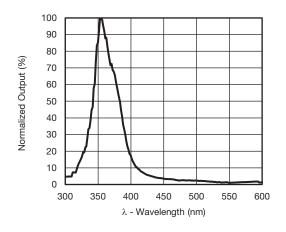
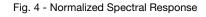


Fig. 3 - I²C Timing for Receive Byte Command Format

TYPICAL PERFORMANCE CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)





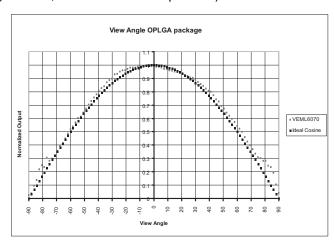
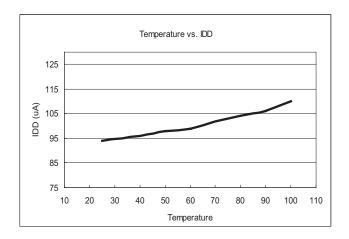


Fig. 5 - Normalized Output vs. View Angle



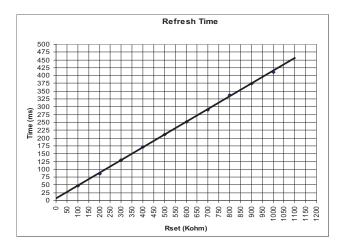


Fig. 6 - I_{DD} vs.Temperature

Fig. 7 - Refresh Time

APPLICATION INFORMATION

Pin Connection with the Host

VEML6070 is a cost effective solution for ultraviolet light sensing with I²C interface. The standard serial digital interface easily accesses "UV light intensity" digital data.

The additional capacitor near the V_{DD} pin is used for power supply noise rejection. For the I²C bus design, the pull-up voltage refers to the I/O of the baseband due to the "open drain" design. The pull-up resistors for the I²C bus design are recommended to be 2.2 k Ω . The circuit diagram as an example is shown in figure 8.

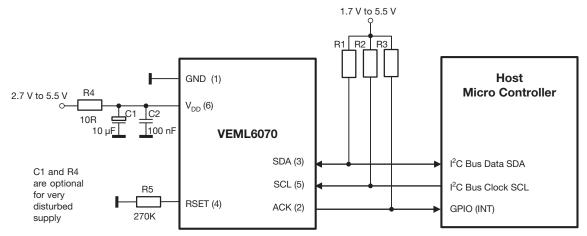


Fig. 8 - Hardware Pin Connection Diagram



Digital Interface

VEML6070 contains a 8-bit command register written via the I²C bus. All operations can be controlled by the command register. The simple command structure enables users to easily program the operation setting and latch the light data from VEML6070. In figure 9, VEML6070 I²C command format description for reading and writing operation between the host and VEML6070 are shown. The white sections indicate host activity and the gray sections indicate VEML6070's acknowledgement of the host access activity.

Receive byte \rightarrow read data from UVS

S Slave address Rd A Light data (1 byte) A P

Send byte \rightarrow write command to UVS

S Slave address Wr A Command (1 byte) A P

S = start condition P = stop condition

A = acknowledge

Shaded area = VEML6070 acknowledge

Fig. 9 - VEML6070 Command Protocol

Slave Address and Function Description

The VEML6070 has one slave address used for write functions (command) and two slave addresses used for read functions (UV data LSB and MSB).

The 7-bit address for write functions is 38h = 0111000**x** resulting in a 70h = 0111000**0** 8-bit address. The 7-bit addresses for read functions are 38h = 0111000**x** for the UV Data LSB and 39h = 0111001**x** for the UV data MSB. This results in a 71h = 0111000**1** and 73h = 0111001**1** 8-bit address, respectively. The 7-bit address 39h should not be used for a write function.

Command Register Format

VEML6070 provides a command to set device operations and sensitivity adjustment. This command is 8-bit long and includes 4 parameter groups for programming. The command format descriptions and register setting explanations are shown in tables 1 and 2.

TABLE 1 -	BLE 1 - COMMAND REGISTER BITS DESCRIPTION						
			COMMAND	FORMAT			
Res	erved	ACK	ACK_THD	Ī	Т	Reserved	SD
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	0	ACK	THD	IT1	IT0	1	SD
			DESCR	IPTION			
Res	erved	Reserved					
А	.CK	Acknowledge	activity setting				
ACK	(_THD	Acknowledge	threshold window s	etting for byte mo	ode usage		
	IT	Integration time setting					
	SD Shutdown mode setting						



TABLE 2 - REGISTER	TABLE 2 - REGISTER TABLE SETTING							
BITS SETTING	DESCRIPTION		BITS SETTING	DESCRIPTION				
Reserved	Set initial value to (0 : 0)		(IT1 : IT0) ⁽¹⁾	(0:0) = ½T (0:1) = 1T (1:0) = 2T (1:1) = 4T				
ACK	0 = disable		Reserved	Set initial value to 1				
AOR	1 = enable		neserved	Set illitial value to 1				
ACK THD	0 = 102 steps		SD	0 = disable				
ACK_THB	1 = 145 steps		30	1 = enable				

Note

Data Access

VEML6070 has 16-bit resolution to give high resolution for light intensity sensing. Examples of the application setting are shown in table 3.

TABLE 3	- DAT	A AC	CESS	DESC	RIPT	ION										
						V	EML60	70 16-BI	T DATA	BUFFE	R					
Data bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Sequence 1	-							—								
Sequence 2									+							—

Notes

- Slave addresses (8 bits) for data read: 0x71 and 0x73
- Data reading sequence for the host:
 - -Set read command to 0x73, read MSB 8 bits of 16 bits light data (sequence 1)
 - -Set read command to 0x71, read LSB 8 bits of 16 bits light data for completing data structure (sequence 2)

Initialization

VEML6070 needs to be initialized while the system's power is on. The initialization includes two major steps: (1) clear ACK state of UVS and (2) fill the initial value, 06 (HEX), into the 0x70 addresses. After the initialization is completed, VEML6070 can be programmable for operation by write command setting from the host. VEML6070 initialization is recommended to be completed within 150 ms.

Acknowledge Activity

VEML6070 provides a function for sending an acknowledge signal (ACK) to the host when the value of sensed UV light is over the programmed threshold (ACK_THD) value. The purpose of the ACK signal is similar to the interrupt feature which informs the host once the sensed data level goes beyond the interrupt threshold setting. VEML6070 has two ACK threshold values, 102 steps and 145 steps.

There are two methods of driving acknowledge condition and read / write command to VEML6070:

(1) If the host implements the INT function, it performs a modified received byte operation to disengage VEML6070's acknowledge signal and acknowledge alert response address (ARA), 0x18 (Hex). A command format for responses to an ARA is shown in figure 10.

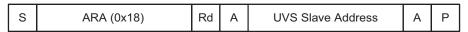


Fig. 10 - Command Format for Responds to an ARA

(2) If the host does not implement this feature, it should periodically access the ARA or read ARA before setting each read / write command.

The behavior of an ACK signal is similar to the INT definition in I²C specification. For the hardware circuit design, this pin connects to an INT pin or GPIO pin of the MCU. The threshold ACK_THD definition is based on the sensitivity setting of

⁽¹⁾ Please refer to table 4, "Example of Refresh Time and R_{SET} Value Relation"



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VEML6070.

The ACK or UVI interrupt function allows the UVI sensing system to perform data pooling based on the interrupt event. The system sensor manager does not need to do continual data pooling and this significantly reduced the MCU loading. The ACK signal can also be used as a trigger event for popping up a warning UVI message.

Refresh Time Determination

VEML6070's refresh time can be determined by the R_{SET} value. Cooperating with the command register setting, the designer has a flexible way of defining the timing for light data collection. The default refresh time is 1T, (IT1 : IT0) = (0 : 1). If the R_{SET} value is changed, the default timing changes and the other parts in the register table also change by comparing itself with the default timing (refer to figure 7).

Table 4 is an example of two R_{SET} resistors that show the timing table that the system designer can use a flexible way to determine the desired refresh time.

TABLE 4 - EXAMPLE OF REFRESH TIME AND R _{SET} VALUE RELATION						
REGISTER	SETTING	REFRES	H TIME			
NEGISTER	SETTING	R _{SET} = 300 kΩ	R _{SET} = 600 kΩ			
	$(0:0) = \frac{1}{2}T$	62.5 ms	125 ms			
(IT1 : IT0)	(0 : 1) = 1T	125 ms	250 ms			
(111.110)	(1:0) = 2T	250 ms	500 ms			
	(1 : 1) = 4T	500 ms	1000 ms			

The designer can decide the refresh timing range requirement first, then choose an appropriate R_{SET} value for the timing range, and then write the correct value for the system application via I^2C protocol.

PACKAGE INFORMATION in millimeters

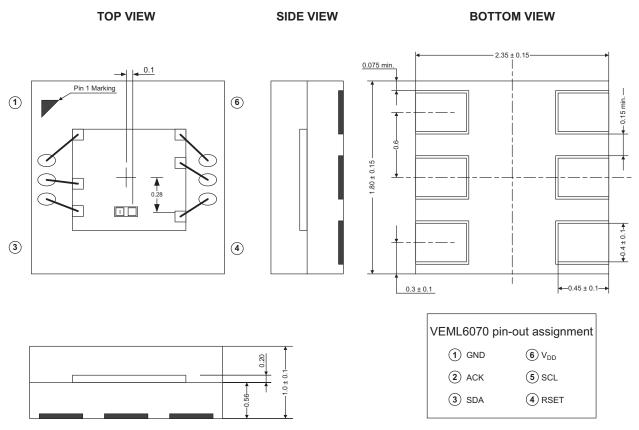


Fig. 11 - VEML6070 A3OP Package Dimensions

LAYOUT NOTICE

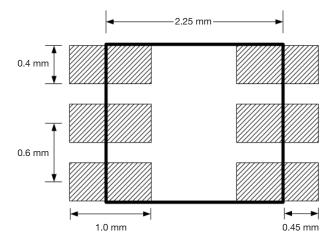


Fig. 12 - VEML6070 OPLGA PCB Layout Footprint



APPLICATION CIRCUIT BLOCK REFERENCE

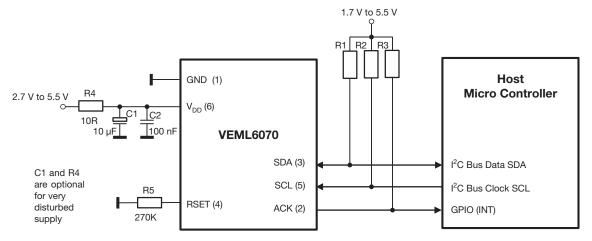


Fig. 13 - VEML6070 Application Circuit

Notes

- V_{DD} range: 2.7 V to 5.5 V
- The pull-up voltage for I²C bus is referring to the I/O specification of baseband

RECOMMENDED STORAGE AND REBAKING CONDITIONS								
PARAMETER	RAMETER CONDITIONS MIN.							
Storage temperature		5	50	°C				
Relative humidity		-	60	%				
Open time	Rebaking process should be done when aluminized envelope reopened	-	-					
Total time	From the date code on the aluminized envelope (unopened)	-	6	months				
Rebaking	Tape and reel: 60 °C	-	22	h				
nebaking	Tube: 60 °C	-	22	h				

RECOMMENDED INFRARED REFLOW

Soldering conditions are based on J-STD-020 C definition.

- 1. After opening the tape and reel, IR reflow process should be done
- 2. IR reflow profile conditions

IR REFLOW PROFILE CONDITION			
PARAMETER	CONDITIONS	TEMPERATURE	TIME
Peak temperature		255 °C + 0 °C / - 5 °C (max.: 260 °C)	10 s
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s
Timing within 5 °C to peak temperature		-	10 s to 30 s
Timing maintained above temperature / time		217 °C	60 s to 150 s
Timing from 25 °C to peak temperature		-	8 min (max.)
Ramp-up rate		3 °C/s (max.)	-
Ramp-down rate		6 °C/s (max.)	-

3. Recommend Normal Solder Reflow is 235 °C to 255 °C

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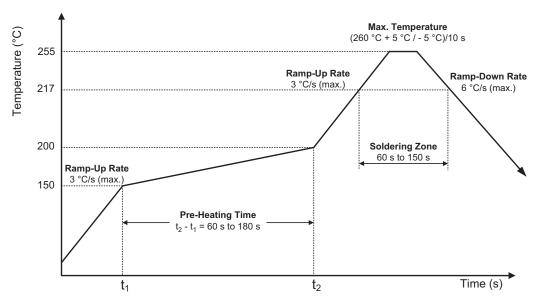


Fig. 14 - VEML6070 A3OP Solder Reflow Profile Chart

RECOMMENDED IRON TIP SOLDERING CONDITION AND WARNING HANDLING

- 1. Solder the device with the following conditions:
 - 1.1. Soldering temperature: 400 °C (max.)
 - 1.2. Soldering time: 3 s (max.)
- 2. If the temperature of the method portion rises in addition to the residual stress between the leads, the possibility that an open or short circuit occurs due to the deformation or destruction of the resin increases.
- 3. The following methods: VPS and wave soldering, have not been suggested for the component assembly.
- 4. Cleaning method conditions:
 - 4.1. Solvent: methyl alcohol, ethyl alcohol, isopropyl alcohol
 - 4.2. Solvent temperature < 45 °C (max.)
 - 4.3. Time: 3 min (min.)

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

TAPE PACKAGING INFORMATION in millimeters

DIMENSION OF CARRIER TAPE

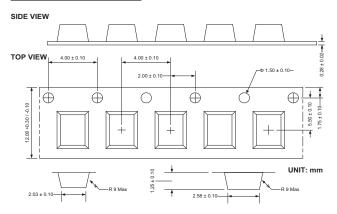


Fig. 15 - VEML6070 A3OP Package Carrier Tape

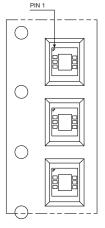


Fig. 16 - Taping Direction

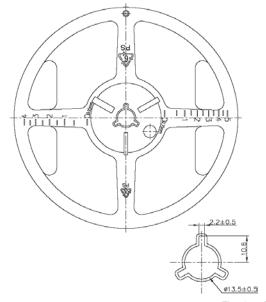
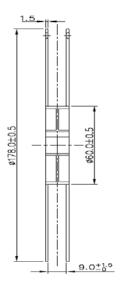


Fig. 17 - Reel Dimension





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